

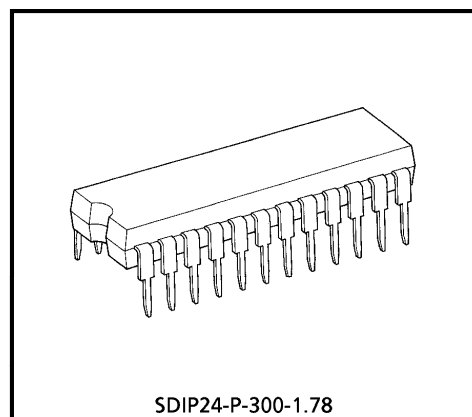
# TD62708N

## 8CH HIGH CURRENT SOURCE DRIVER

The TD62708N is comprised of eight source current output stages and  $\overline{\text{ENABLE}}$  inputs which can gate the outputs.

TD62708N features a large output source current of 1.8A and minimized output voltage change vs output current change. These features make the device optimum for driving the matrix of ink jet printer print heads, LEDs, and the scan side of resistor matrixes.

Before using this device, note the thermal conditions for usage.

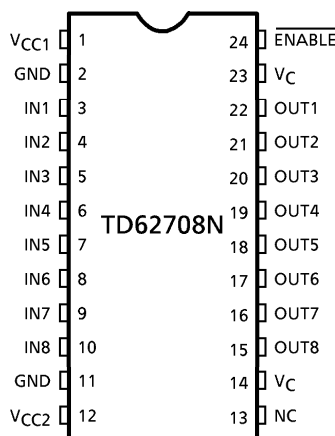


Weight : 1.2g (Typ.)

### FEATURES

- Input terminal : High active
- $\overline{\text{Enable}}$  terminal : Low input output active mode
- Output current :  $I_{\text{OUT}} = 1.8\text{A (MAX)}$
- A little change of output voltage  
:  $\Delta V_{\text{OH1}} \leq 0.45\text{V}$   
(at  $I_{\text{OH}} = 0.18\text{A} \sim 1.44\text{A}$ )
- Package type : DIP24N
- Input compatible with TTL, 5V CMOS

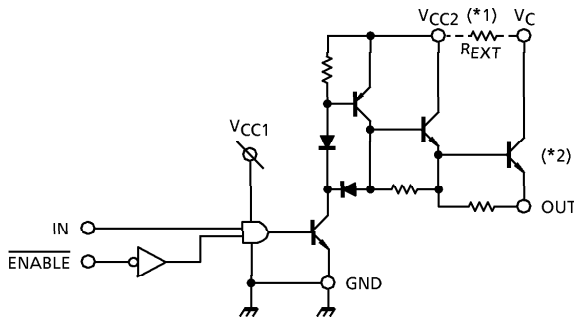
### PIN CONNECTION (TOP VIEW)



961001EBA2

● TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.

SCHEMATICS (EACH DRIVER)

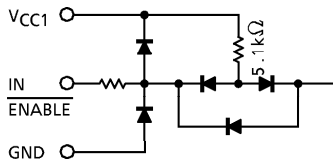


FUNCTION

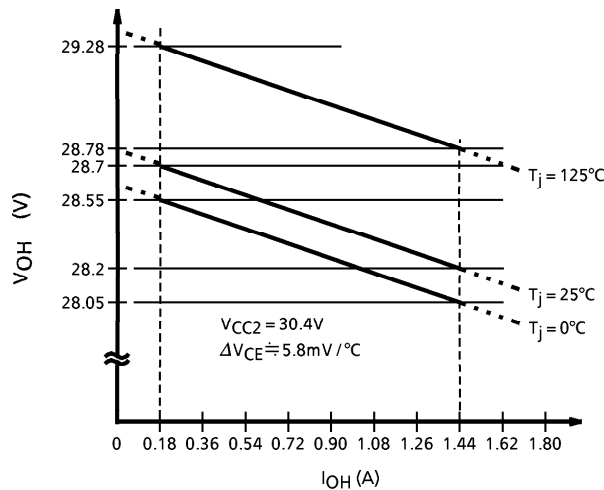
IN	ENABLE	OUT
H	L	ON
L	L	OFF
Don't Care	H	OFF

- (\*1) For normal use, connect VCC2 and Vc.  
For applications whose thermal conditions are more demanding, TOSHIBA recommends an external resistor (R<sub>EXT</sub> : approx. 0.9Ω/2W) be connected between VCC2 and Vc.
- (\*2) When connecting an external resistor between BV<sub>CC2</sub> and Vc, to avoid parasitic sub currents, set the voltage between Vc and OUT as 0.3V or more.  
Set the external resistor value so that the voltage between Vc and OUT is 0.3V or more at the maximum temperature of the operating temperature range.

INPUT CIRCUIT : IN, ENABLE



(Note) Since the states of the input pins (pins 3 to 10) are the same as those at high-level input, set the pins for unused channels to GND.



- Output voltage (Temperature characteristic)  
Output Voltage (V<sub>OH</sub>) has a Temperature Characteristic of 5.8mV/°C, care must be taken to keep Junction Temp (T<sub>j</sub>) within safety Limits.

961001EBA2'

● The products described in this document are subject to foreign exchange and foreign trade control laws.  
● The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.  
● The information contained herein is subject to change without notice.

**MAXIMUM RATINGS** (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage 1	V <sub>CC1</sub>	-0.5~7.0	V
Supply Voltage 2	V <sub>CC2</sub>	-0.5~4.0	
Output Current	I <sub>OUT</sub>	1.8 (Note)	A
Input Voltage	V <sub>IN</sub>	-0.5~7.0	V
Input Current	I <sub>IN</sub>	±4.0	mA
Power Dissipation	P <sub>D</sub>	1.78	W
Janction Temperature	T <sub>j</sub>	150	°C
Operating Temperature	T <sub>opr</sub>	-40~85	°C
Storage Temperature	T <sub>stg</sub>	-55~150	°C

(Note 1) 1.8A / ch (32 $\mu$ s, Duty $\leq$ 76%), Each Channel should not be switched on at same time.

(Note 2) When mounting the device on the PC board, and the temperature exceeds 25°C, derate to 14.2mW/°C.

**RECOMMENDED OPERATING CONDITIONS**

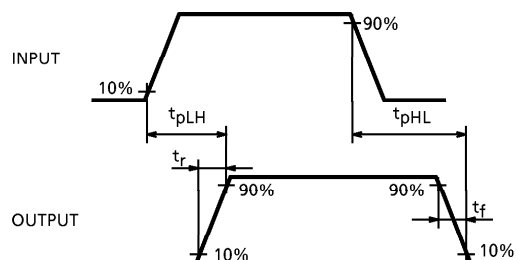
CHARACTERISTIC	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage 1	V <sub>CC1</sub>	—	4.5	5.0	5.5	V
Supply Voltage 2	V <sub>CC2</sub>	—	—	—	3.0	
Output Current	I <sub>OH</sub> (Note)	—	—	—	1.44	A
Input Voltage	V <sub>IN</sub> (H)	V <sub>IN</sub> = H, V <sub>CC1</sub> = 5.0V	2.4	—	V <sub>CC</sub>	V
	V <sub>IN</sub> (L)	V <sub>IN</sub> = L, V <sub>CC1</sub> = 5.0V	0	—	0.4	V
	V <sub>EN</sub> (H)	V <sub>EN</sub> = H, V <sub>CC1</sub> = 5.0V	2.4	—	V <sub>CC</sub>	V
	V <sub>EN</sub> (L)	V <sub>EN</sub> = L, V <sub>CC1</sub> = 5.0V	0	—	0.4	V
Operating Temperature	T <sub>opr</sub>	—	0	—	70	°C

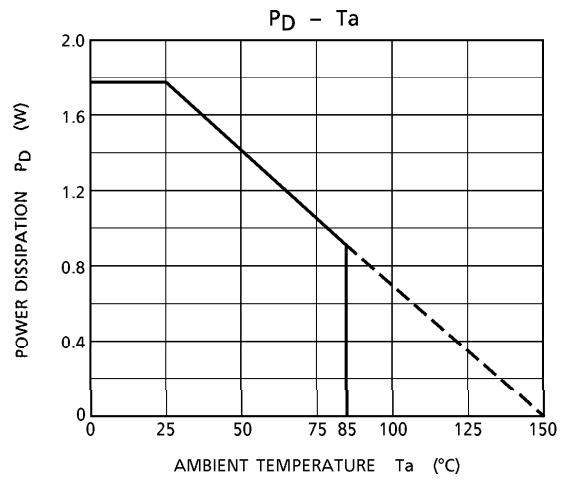
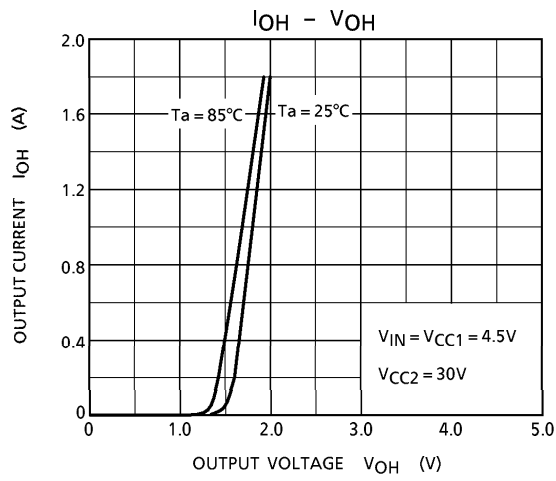
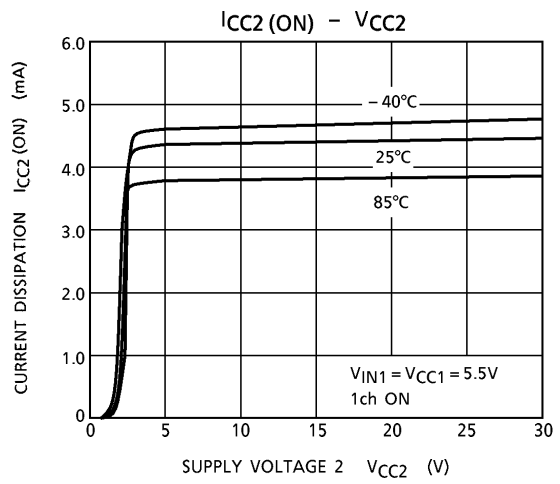
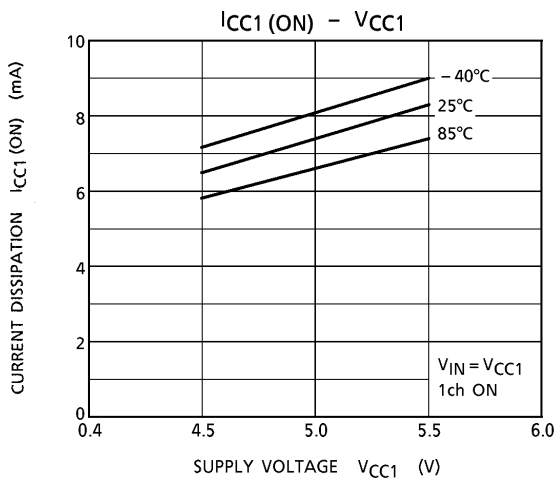
(Note) Each Channel should not be switched on at same time.

**ELECTRICAL CHARACTERISTICS (Ta = 0~70°C)**

CHARACTERISTIC	SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Leakage Current	I <sub>L1</sub>	—	V <sub>CC1</sub> = 7.0V, I <sub>N</sub> = L, E <sub>N</sub> = H	—	—	100	μA	
	I <sub>L2</sub>		V <sub>CC2</sub> = 30V, I <sub>N</sub> = L, E <sub>N</sub> = H	—	—	100		
	I <sub>L3</sub>		V <sub>C</sub> = 30V, I <sub>N</sub> = L, E <sub>N</sub> = H	—	—	100		
Input Current	I <sub>IN1</sub>	—	V <sub>CC1</sub> = 5.0V, V <sub>IN</sub> = 5.0V	—	0	10	μA	
	I <sub>IN2</sub>		V <sub>CC1</sub> = 5.0V, V <sub>IN</sub> = 0V	0.55	0.8	1.1	mA	
	I <sub>EN1</sub>		V <sub>CC1</sub> = 5.0V, V <sub>EN</sub> = 5.0V	—	0	10	μA	
	I <sub>EN2</sub>		V <sub>CC1</sub> = 5.0V, V <sub>EN</sub> = 0V	0.55	0.8	1.1	mA	
Input Voltage	V <sub>INH</sub>	—	V <sub>CC1</sub> = 5.0V	2.0	—	V <sub>CC</sub> + 0.4	V	
	V <sub>INL</sub>		V <sub>CC1</sub> = 5.0V	GND - 0.4	—	0.8		
	V <sub>ENH</sub>		V <sub>CC1</sub> = 5.0V	2.0	—	V <sub>CC</sub> + 0.4		
	V <sub>ENL</sub>		V <sub>CC1</sub> = 5.0V	GND - 0.4	—	0.8		
Output Voltage	V <sub>OH1</sub>	—	I <sub>OH</sub> = 1.44A	V <sub>CC2</sub> = 30V	27.0	27.5	—	V
	V <sub>OH2</sub>		I <sub>OH</sub> = 0.18A		27.5	28.0	—	
Change Of Output Voltage	ΔV <sub>OH1</sub>	—	V <sub>OH1</sub> - V <sub>OH2</sub> (T <sub>j</sub> = 25°C)	—	0.3	0.45	V	
Output Voltage Temperature Characteristic	ΔV <sub>CE2</sub>	—	V <sub>OH</sub> (T <sub>j</sub> = 105°C) - V <sub>OH</sub> (T <sub>j</sub> = 25°C) I <sub>OH</sub> = 0.18A	—	0.5	—	V	
Propagation Delay Time	t <sub>pLH1</sub>	—	V <sub>CC1</sub> = V <sub>IN</sub> = 4.5V V <sub>CC2</sub> = 30V	I <sub>OUT</sub> = 0.18A	—	0.1	1.0	μs
	t <sub>pLH2</sub>			I <sub>OUT</sub> = 1.44A	—	0.2	1.0	
	t <sub>pHL1</sub>			I <sub>OUT</sub> = 0.18A	—	1.0	3.5	
	t <sub>pHL2</sub>			I <sub>OUT</sub> = 1.44A	—	1.5	3.5	
Rise Time	t <sub>r1</sub>	—	V <sub>CC1</sub> = V <sub>IN</sub> = 4.5V V <sub>CC2</sub> = 30V	I <sub>OUT</sub> = 0.18A	—	0.05	0.5	μs
	t <sub>r2</sub>			I <sub>OUT</sub> = 1.44A	—	0.1	0.5	
Fall Time	t <sub>f1</sub>	—	V <sub>CC1</sub> = V <sub>IN</sub> = 4.5V V <sub>CC2</sub> = 30V	I <sub>OUT</sub> = 0.18A	—	0.3	2.0	μs
	t <sub>f2</sub>			I <sub>OUT</sub> = 1.44A	—	0.3	2.0	

**AC TEST CIRCUIT**





● Thermal calculation

Where, power dissipation =  $(V_{CC1} \times I_{CC1}) + (V_{CC2} \times I_{CC2} \times ch \times Duty) + (V_{OH} \times I_{OH} \times ch \times Duty)$   
 and the transient thermal resistance of DIP24N  $(R + h) = 70^\circ\text{C} / \text{W}$ , the junction temperature ( $T_j$ ) is :

$$T_j (\text{MAX}) \geq (P_D \times R + h) + T_a (\text{MAX}) \dots \dots \text{expression (A)}$$

Conditions :  $V_{CC1} = 5\text{V}$  ( $I_{CC1} = \text{approx. } 8\text{mA}$ ),  $V_{CC2} = 30\text{V}$  ( $I_{CC2} = \text{approx. } 5\text{mA}$ ), 1ch on  
 $V_{OH} = \text{approx. } 2.0\text{V}$ ,  $I_{OH} = 1.44\text{A}$ ,  
 $T_j (\text{MAX}) = 120^\circ\text{C}$ , ambient temperature (MAX) :  $T_a = 70^\circ\text{C}$

(1) When  $V_{CC2}$  and  $V_C$  are connected :

Due to expression (a), for designs without cooling fins, duty = approx. 20% is required, as the following calculation shows :

$$\begin{aligned} P_D &= (5\text{V} \times 8\text{mA}) + (30\text{V} \times 5\text{mA} \times 1\text{ch} \times 0.2) + (2.0\text{V} \times 1.44\text{A} \times 1\text{ch} \times 0.2) \\ &= 40\text{mW} + 30\text{mW} + 576\text{mW} \\ &= 646\text{mW} \end{aligned}$$

$$T_j (\text{MAX}) \geq (646\text{mW} \times 70^\circ\text{C} / \text{W}) + 70^\circ\text{C} = \text{approx. } 115^\circ\text{C} \dots \dots \text{OK}$$

(2) When an external resistor ( $R_{EXT} = 0.9\Omega$ ) is connected between  $V_{CC2}$  and  $V_C$  :

Change the above condition :

$$\begin{aligned} V_{OH} &= 2.0\text{V} - (0.9\Omega \times 1.44\text{A}) \\ &= 0.7\text{V} \end{aligned}$$

$P_D$  when substituted in expression (a) :

$$\begin{aligned} P_D &= (5\text{V} \times 8\text{mA}) + (30\text{V} \times 5\text{mA} \times 1 \times 0.2) + (0.7\text{V} \times 1.44\text{A} \times 1 \times 0.2) \\ &= 40\text{mW} + 30\text{mW} + 202\text{mW} \\ &= 272\text{mW} \end{aligned}$$

$$T_j (\text{MAX}) \geq (272\text{mW} \times 70^\circ\text{C} / \text{W}) + 70^\circ\text{C} = \text{approx. } 89^\circ\text{C}$$

when  $T_j (\text{MAX}) = 120^\circ\text{C}$

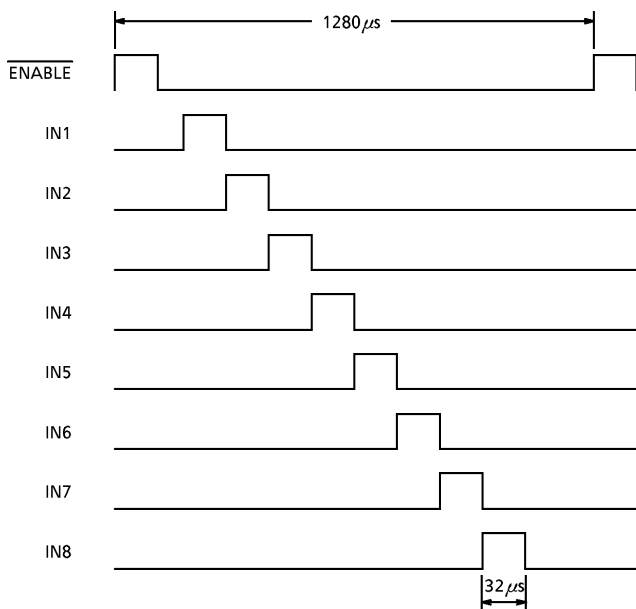
∴ (calculation omitted)

Duty can be approx. 58%.

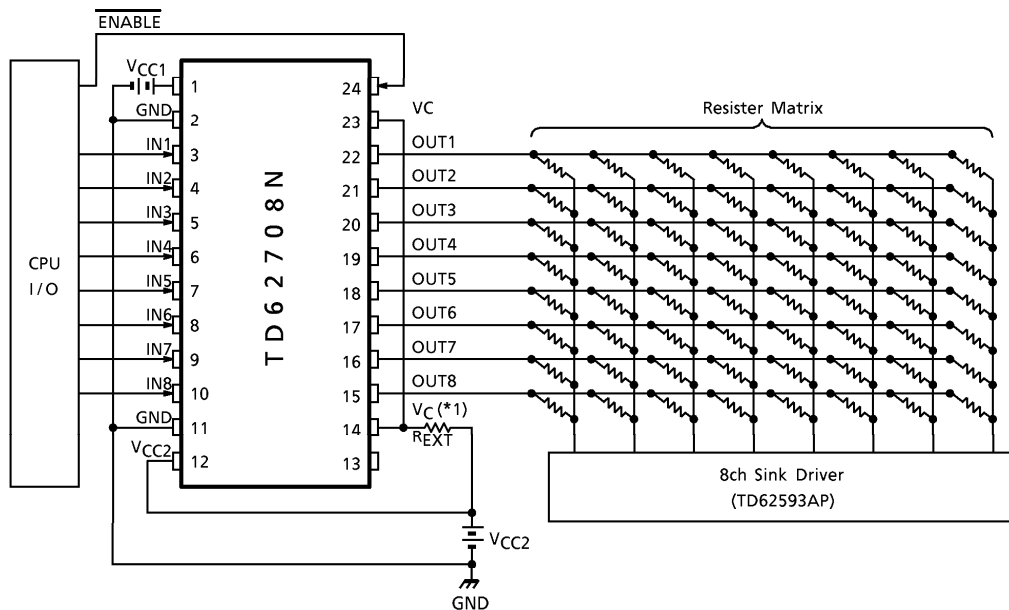
- Duty (when duty = 20%)

Condition : pulse width = 32μs (cycle = 1280μs)

$$\text{Duty} = (32\mu\text{s} \times 8\text{ch}) \div 1280\mu\text{s} = 20\%$$



APPLICATION CIRCUIT



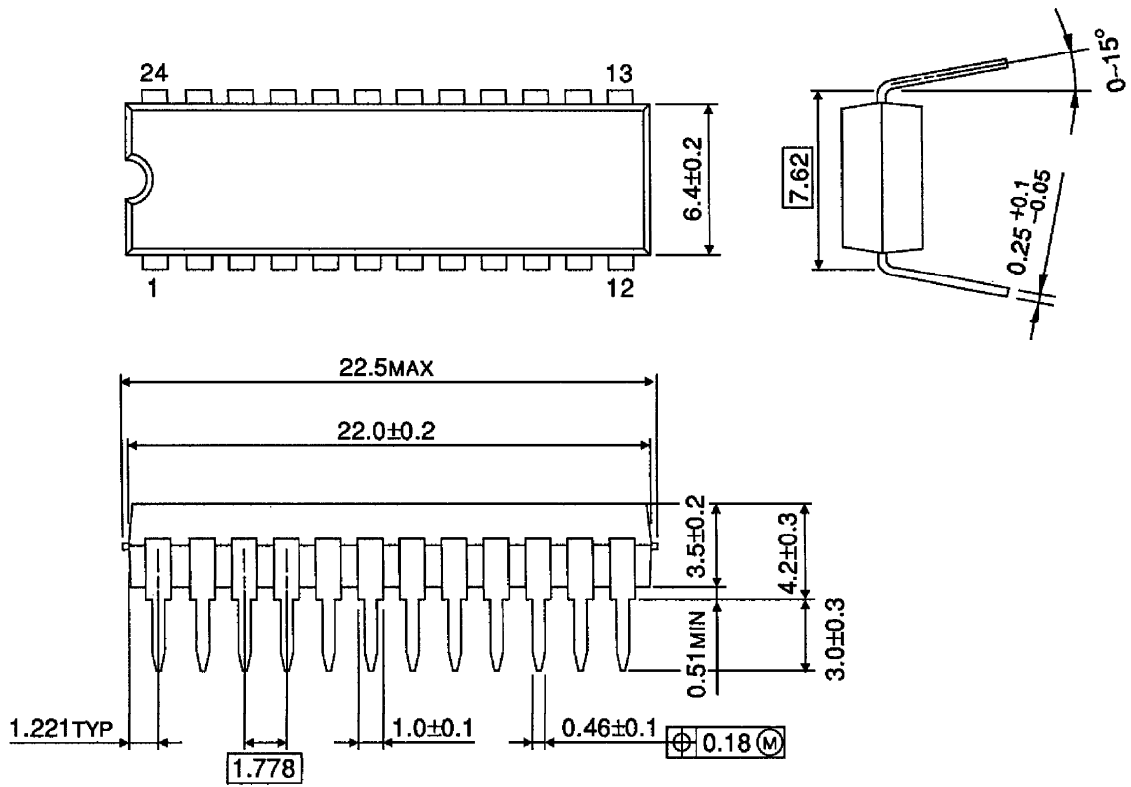
(Note 1) TOSHIBA recommends external resistor  $R_{EXT}$  (approx.  $0.9\Omega / 2W$ ) be connected between  $V_{CC2}$  and  $V_C$ .

PRECAUTIONS for USING

Utmost care is necessary in the design of the output line,  $V_{CC}$  ( $V_{CC1}$ ,  $V_{CC2}$ ,  $V_C$ ) and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

OUTLINE DRAWING  
SDIP24-P-300-1.78

Unit : mm



Weight : 1.2g (Typ.)